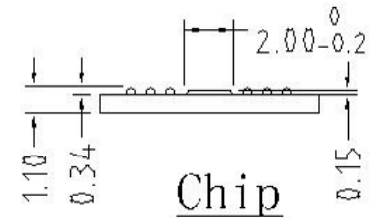
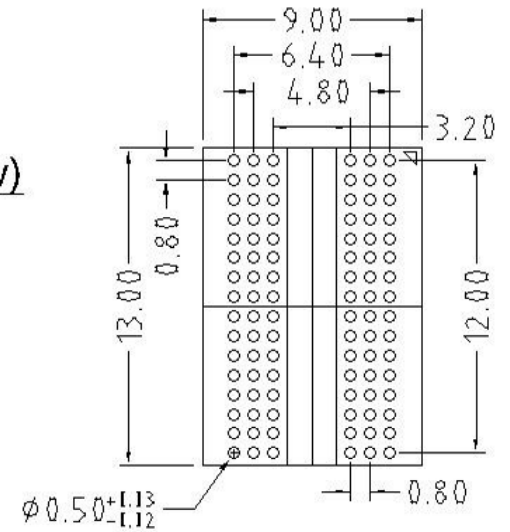
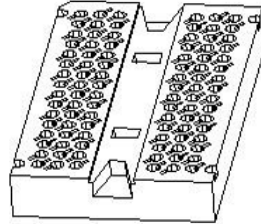
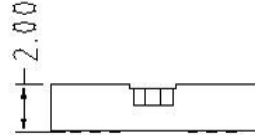


PCB PATTERN (Top View)



Chip

1、 MATERIAL AND FINISH

- 1、 SOCKET BASE : LCP
- 2、 CONTACTS : BeCu, SELECTIVE Au-AuFLASH OVER NI PLATING

2、 PERFORMANCE

- 1、 Insulation Resistance : 1000MΩ or more at DC 100V
- 2、 Dielectric Withstanding Voltage: 100V AC for one minute
- 3、 Contact Resistance 50 mΩ , MAX. at 10mA and 20mV MAX.(Initial)
- 4、 Operation Temperature -50°C~+150°C
- 5、 Life Span 10,000 Times (Mechanical)
- 6、 Operation Force 2.0 Kg MAX

△C				JWS NS			PART NAME	DDR3X16-96
△P				VAL-A	30A	1:1	TITLE	
△A				GIN	1	mm		
REV	01	01	01	01	01	01		
A11-0A10X				A11-0A10X				

JRS